**Product data sheet** 

## 1. General description

Planar Low  $V_F$  Schottky barrier rectifier encapsulated in a CFP15B (SOT1289B) power and flat lead Surface-Mounted Device (SMD) plastic package.

### 2. Features and benefits

- · Very low forward voltage
- High power capability due to clip-bond technology
- · Small and thin SMD plastic package

### 3. Applications

- · High efficiency DC-to-DC conversion
- Low voltage rectification
- · Switch mode power supply
- Freewheeling application
- · Reverse polarity protection
- OR-ing

### 4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I <sub>F(AV)</sub>	average forward current	square-wave pulse; $\delta$ = 0.5; f = 20 kHz; $T_{sp} \le 173 ^{\circ}\text{C}$		-	-	3	Α
V <sub>R</sub>	reverse voltage	T <sub>j</sub> = 25 °C		-	-	40	V
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 3 A; pulsed; T <sub>j</sub> = 25 °C	[1]	-	425	490	mV
I <sub>R</sub>	reverse current	V <sub>R</sub> = 40 V; pulsed; T <sub>j</sub> = 25 °C	[1]	-	30	120	μΑ

<sup>[1]</sup> Very short pulse, in order to maintain a stable junction temperature.

# 5. Pinning information

**Table 2. Pinning information** 

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	Α	anode		
2	Α	anode		K A
3	K	cathode	12	aaa-009063
			CFP15B (SOT1289B)	



# 6. Ordering information

#### **Table 3. Ordering information**

Type number	Package	ackage						
	Name	Description	Version					
PMEG040V030EPE		plastic, thermal enhanced ultra thin SMD package; 3 leads; 2.13 mm pitch; 5.8 x 4.3 x 0.95 mm body	SOT1289B					

## 7. Marking

#### Table 4. Marking codes

Type number	Marking code
PMEG040V030EPE	040V U03E

## 8. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
$V_R$	reverse voltage	T <sub>j</sub> = 25 °C		-	40	V
I <sub>F</sub>	forward current	$\delta$ = 1; $T_{sp} \le 172 ^{\circ}\text{C}$		-	4.2	А
I <sub>F(AV)</sub>	average forward current	square-wave pulse; $\delta$ = 0.5; f = 20 kHz; $T_{sp} \le 173  ^{\circ}\text{C}$		-	3	A
I <sub>FSM</sub>	non-repetitive peak forward current	half sine-wave pulse; $t_p = 8.3 \text{ ms}$ ; $T_{j(init)} = 25 \text{ °C}$		-	120	A
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C	[1]	-	1.66	W
			[2]	-	2.15	W
Tj	junction temperature			-	175	°C
T <sub>amb</sub>	ambient temperature			-55	175	°C
T <sub>stg</sub>	storage temperature			-65	175	°C

<sup>[1]</sup> Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

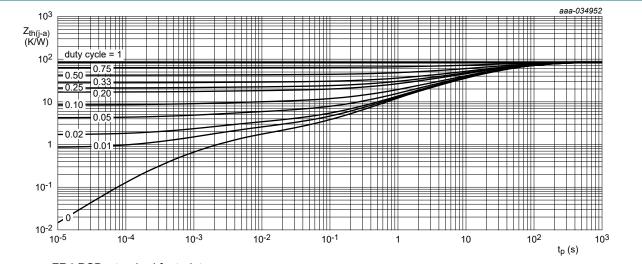
Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.

## 9. Thermal characteristics

**Table 6. Thermal characteristics** 

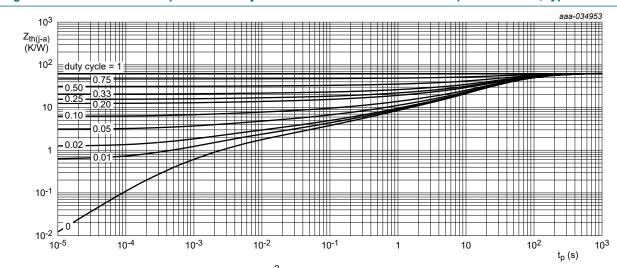
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R <sub>th(j-a)</sub> thermal resistance from junction to ambient	thermal resistance from	in free air	[1] [2]	-	-	90	K/W
		[1] [3]	-	-	70	K/W	
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point		[4]	-	-	3	K/W

- [1] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses P<sub>R</sub> are a significant part of the total power losses.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.
- [4] Soldering point of cathode tab.



FR4 PCB, standard footprint

Fig. 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



FR4 PCB, mounting pad for cathode 1 cm<sup>2</sup>

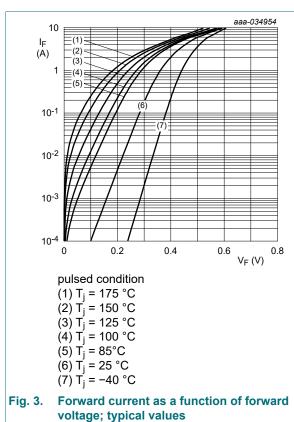
Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

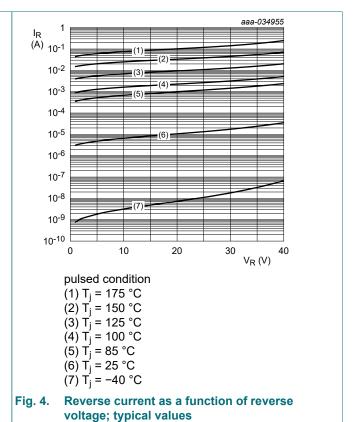
### 10. Characteristics

**Table 7. Characteristics** 

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V <sub>(BR)R</sub>	reverse breakdown voltage	$I_R = 3 \text{ mA}$ ; pulsed; $T_j = 25 \text{ °C}$	[1]	40	-	-	V
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 1 A; pulsed; T <sub>j</sub> = 25 °C	[1]	-	360	420	mV
		I <sub>F</sub> = 3 A; pulsed; T <sub>j</sub> = 25 °C	[1]	-	425	490	mV
		I <sub>F</sub> = 3 A; pulsed; T <sub>j</sub> = -40 °C	[1]	-	490	580	mV
		I <sub>F</sub> = 3 A; pulsed; T <sub>j</sub> = 125 °C	[1]	-	340	420	mV
I <sub>R</sub>	reverse current	V <sub>R</sub> = 40 V; pulsed; T <sub>j</sub> = 25 °C	[1]	-	30	120	μΑ
C <sub>d</sub>	diode capacitance	V <sub>R</sub> = 1 V; f = 1 MHz; T <sub>j</sub> = 25 °C		-	370	-	pF
		V <sub>R</sub> = 10 V; f = 1 MHz; T <sub>j</sub> = 25 °C		-	125	-	pF
t <sub>rr</sub>	reverse recovery time step recovery	$I_F = 0.5 \text{ A}; I_R = 0.5 \text{ A}; I_{R(meas)} = 0.1 \text{ A};$ $T_j = 25 ^{\circ}\text{C}$		-	12	-	ns
	reverse recovery time ramp recovery	$dI_F/dt = 100 \text{ A/}\mu\text{s}; I_F = 3 \text{ A}; V_R = 30 \text{ V};$ $T_j = 25 ^{\circ}\text{C}$		-	11	-	ns
$V_{FRM}$	peak forward recovery voltage	$I_F = 0.5 \text{ A}; \text{ d}I_F/\text{d}t = 20 \text{ A/}\mu\text{s}; T_j = 25 °C$		-	340	-	mV

[1] Very short pulse, in order to maintain a stable junction temperature.





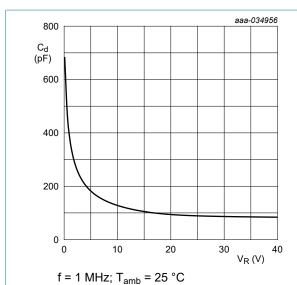
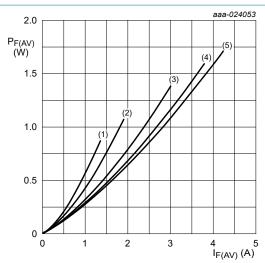
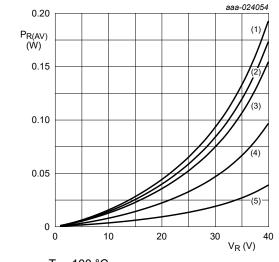


Fig. 5. Diode capacitance as a function of reverse voltage; typical values



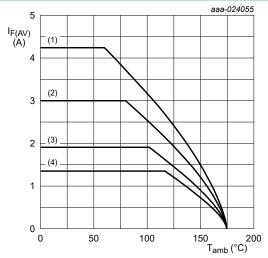
 $T_j = 100 \,^{\circ}\text{C}$   $(1) \, \delta = 0.1$   $(2) \, \delta = 0.2$   $(3) \, \delta = 0.5$   $(4) \, \delta = 0.8$  $(5) \, \delta = 1$ 

Fig. 6. Average forward power dissipation as a function of average forward current; typical values



 $T_j = 100 \,^{\circ}\text{C}$   $(1) \, \delta = 1$   $(2) \, \delta = 0.9$   $(3) \, \delta = 0.8$   $(4) \, \delta = 0.5$  $(5) \, \delta = 0.2$ 

Fig. 7. Average reverse power dissipation as a function of reverse voltage; typical values



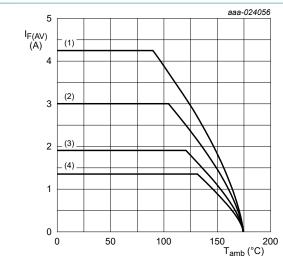
FR4 PCB, standard footprint

 $T_{j}$  = 175 °C (1)  $\delta$  = 1; DC (2)  $\delta$  = 0.5; f = 20 kHz

(3)  $\delta = 0.2$ ; f = 20 kHz

(4)  $\delta = 0.1$ ; f = 20 kHz

Fig. 8. Average forward current as a function of ambient temperature; typical values



FR4 PCB, mounting pad for cathode 1 cm<sup>2</sup>

 $T_i = 175 \,{}^{\circ}\text{C}$ 

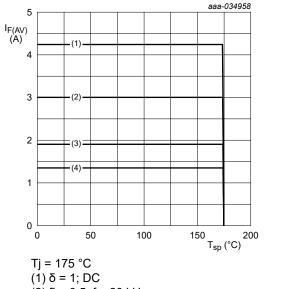
 $(1) \delta = 1; DC$ 

(2)  $\delta = 0.5$ ; f = 20 kHz

(3)  $\delta = 0.2$ ; f = 20 kHz

(4)  $\delta = 0.1$ ; f = 20 kHz

Fig. 9. Average forward current as a function of ambient temperature; typical values



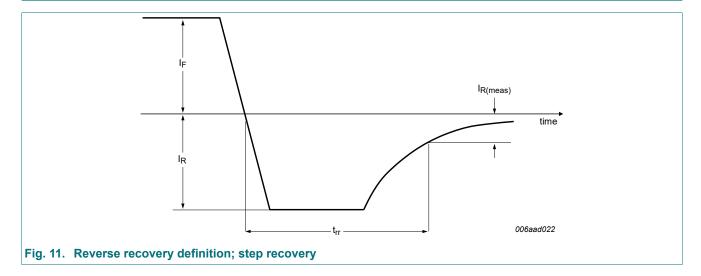
(2)  $\delta$  = 0.5; f = 20 kHz

(3)  $\delta$  = 0.2; f = 20 kHz

 $(4) \delta = 0.1$ ; f = 20 kHz

Fig. 10. Average forward current as a function of solder point temperature; typical values

### 11. Test information



**Product data sheet** 

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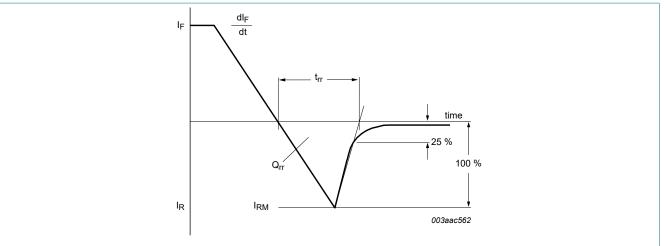


Fig. 12. Reverse recovery definition; ramp recovery

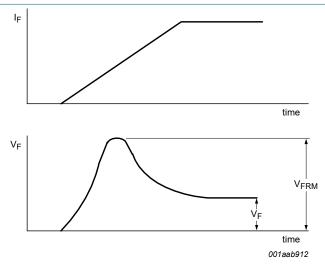


Fig. 13. Forward recovery definition

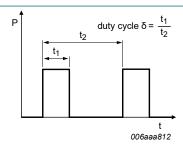


Fig. 14. Duty cycle definition

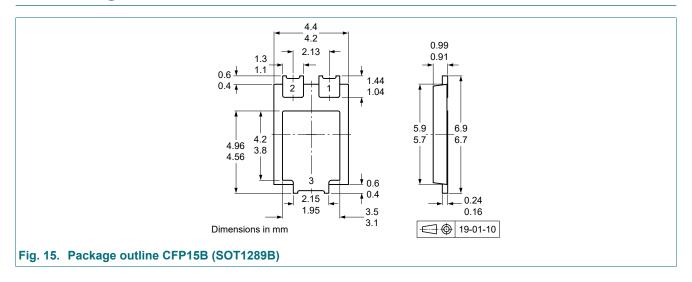
The current ratings for the typical waveforms are calculated according to the equations:

 $I_{F(AV)} = I_M \times \delta$  with  $I_M$  defined as peak current

 $I_{RMS} = I_{F(AV)}$  at DC, and  $I_{RMS} = I_{M} \times \sqrt{\delta}$ 

with  $I_{\mbox{\scriptsize RMS}}$  defined as RMS current.

# 12. Package outline



## 13. Soldering

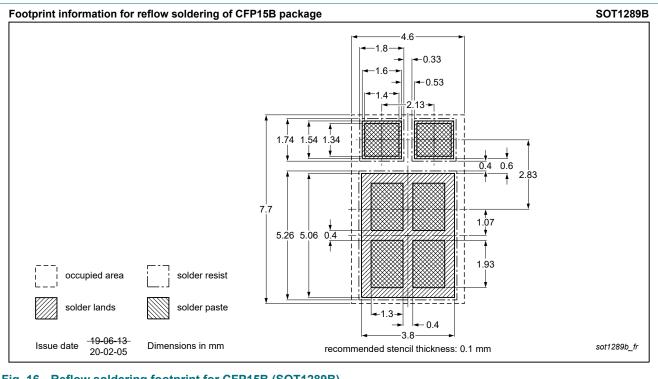


Fig. 16. Reflow soldering footprint for CFP15B (SOT1289B)

# 14. Revision history

#### Table 8. Revision history

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Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PMEG040V030EPE v.3	20221024	Product data sheet	-	PMEG040V030EPE v.2
Modifications:	Characteris	stics: Typo corrected in o	conditions o	f V <sub>F</sub> at T <sub>j</sub> = 125 °C
PMEG040V030EPE v.2	20220718	Product data sheet	-	PMEG040V030EPE v.1
PMEG040V030EPE v.1	20220421	Preliminary data sheet	-	-

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#### **Data sheet status**

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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